Customer No.: 31561 Application No.: 10/708,016 Docket No.: 12030-US-PA

AMENDMENT

In The Claims:

1. (currently amended) A pixel structure, adapted to be disposed on a substrate, comprising:

a scan line, disposed on the substrate;

a data line, disposed on the substrate;

an active element, disposed near to an intersection of the scan line and the data line on the substrate, and electrically coupled to the scan line and the data line;

a capacitor electrode, disposed on the substrate;

a pixel electrode, disposed over the capacitor-electrode the substrate and electrically coupled to the active element, wherein the pixel electrode and the capacitor electrode form a pixel storage capacitor; and

an electrical field shielding layer, disposed between the data line and the pixel electrode.;

a capacitor electrode, disposed between the substrate and the pixel electrode, and the capacitor electrode does not cover the data line and the scan line.

2. (original) The pixel structure of claim 1, wherein the active element comprises a low temperature polysilicon thin film transistor.

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3. (original) The pixel structure of claim 2, further comprising a drain/source conductive

layer, wherein the active element is electrically coupled to the data line and the pixel electrode

through the drain/source conductive layer.

Claims 4-5 (canceled).

6. (currently amended) The pixel structure of claim 1, further comprising a transparent

capacitor electrode, disposed between the capacitor electrode and the pixel electrode with the

capacitor electrode disposed between the transparent capacitor electrode and the pixel electrode,

wherein the capacitor electrode, the transparent capacitor electrode and the pixel electrode form

the pixel storage capacitor, and the capacitor electrode is made from a transparent material.

7. (currently amended) The pixel structure of claim 6, wherein the active element is

directly electrically coupled to the capacitor electrode or the transparent capacitor electrode.

8. (currently amended) The pixel structure of claim 6, wherein the active element is

electrically coupled to the capacitor or the transparent capacitor electrode through the pixel

electrode.

9. (original) The pixel structure of claim 6, wherein the transparent capacitor electrode is

made from indium tin oxide or indium zinc oxide.

Claims 10-11. (canceled)

12. (original) The pixel structure of claim 1, wherein the capacitor electrode, the electrical

field shielding layer and the pixel electrode are made from indium tin oxide or indium zinc oxide.

Claims 13-25. (canceled).

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